



Silicom C5010X Data Center NIC

Product Description

Silicom C5010X is an advanced data processing network interface controller, featuring cutting edge I/O and data processing capabilities, optimized for virtualized cloud, cloud native or bare metal virtualization. Completely implementing I/O workload using industry standard interfaces, Silicom C5010X is operated using stock virtio and NVMe drivers, implementing a true hardware virtio and NVMe PCIe interface. Combining two powerful engines – Intel® Stratix® 10 DX 1100 FPGA and Intel® Xeon® D-1612 SoC (x86 CPU, 4 cores, 8 threads) – Silicom C5010X data processing NIC brings together the power and flexibility of FPGA and the wealth of the x86 ecosystem.

A unique 3-way path for application optimization guarantees fast results. The presence of a x86 based CPU allows you to leverage existing software assets, where the FPGA flexibly enables extremely performant data path implementation:

- 1) In the first stage, the card can serve as a standard NIC with minimal configuration changes, with minimal orchestration modification;
- 2) Second stage include a migration of data plane and VM switching functionality from main host down to x86 CPU cores on card:
- 3) The third stage involves data path implementation on the FPGA.

Silicom C5010X can be deployed as a virtio network accelerator, a virtio storage accelerator, a NVMe storage (network) controller, a RDMA OFED controller, either separately or all at the same time. Further implementations such as flow filtering, encryption, compression, deduplication and machine learning, are facilitated by C5010X facilitates as complete infrastructure implementation on an NIC.

As the data path is implemented on the card, fewer risks and vulnerabilities are left to the cloud data center infrastructure.

Storage data paths in a cloud environment are often associated with the use of a storage attached network (SAN), serving the compute nodes over the network. The use of an x86 CPU core NIC with FPGA facilitates for allows relatively easy implementation of storage volume virtualizations, accessible on the host using stock storage software stacks, such as NVMe.

Key Use Cases

- Virtual Cloud
- Bare Metal Cloud
- NVFi
- Secure Infrastructure
- Cloud Storage

Key Features

- Intel® Xeon® D-1612 @ 1.5GHz 4 core, 8 threads
- Intel® Stratix® 10 DX 1100
- virtio-net and virtio-blk over PCIe
- Dual 25GbE
- PCIe v4 x 8 (x16 physical)

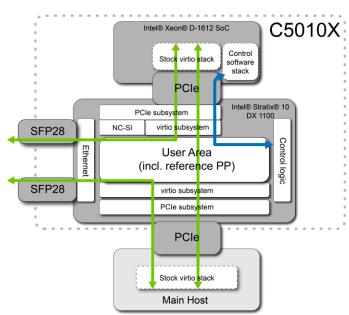


Figure 1 – Various data paths (green) and control paths (blue) are enabled on Silicom C5010X

Technical Specifications

Network Interface		
IEEE standard	IEEE 802.3 10GE, 25GE	
Interfaces	 Physical interface: 2 x SFP28 slots Supports SFP+/SFP28 modules with Multimode SR (850nm), single mode LR (1310nm), multimode LRM (1310 nm), or Direct Attached Copper (Twinax) and others Data rate: 2x10, 2x25, Gbps Support for SyncE 	
Interfaces		
Network	■ Dual 25GbE, using SFP28	
Host	 PCle gen4 x 8 (x16 physical) NCSI RBT Support for SMBUS 	
SoC	PCle v3 x 8USB NICUART	

General Technical Specifications		
SoC details	Intel® Xeon® D-1612 4 x86 64 bit cores @1.5GHz 8 threads 6MB cache VT-d, VT-x Intel® AVX2 AES-NI 16GB DDR ECC	
FPGA Details	Intel® Stratix 10 DX 1100 Intel® Hyperflex™ core architecture Intel® Embedded Multi-die Interconnect Bridge (EMIB) PCIx Gen4 x16 hard IP, SRIOV Fixed point and IEEE 754 compliant floating-point variable precision digital signal processing (DSP) block Internal memory M20K, 107Mb SRAM, 47.25Mb MLAB 1,325,000 ALM Quad-core 64-bit Arm® Cortex®-A53 embedded processor @1.5 GHz 4GB DDR	
Configuration	 Configuration flash can be made to support multiple boot images for automatic fallback to fail safe Upload of FPGA configuration to flash via PCIe Direct FPGA configuration via the onboard JTAG dongle 	
On-board Memory	 16GB DDR ECC for SoC 4GB DDR for FPGA User configurable space in flash RAM for permanent storage Configuration flash RAM for boot images 	
On-board Clock	 PCIe clock: 100 MHz Core Clock 125Mhz 2 x differential 312.5 MHz SerDes clock for Ethernet 2 x differential 266.67 MHz/300MHz/333.33MHz clock for Memory Calibration clock 125MHz, 100MHz, 25MHz 50 MHz clock 	

Additional Board Support	 On-board power and temperature sensors (via SMBus/I2C) FPGA controlled Link and Activity LED for each port. 2 for each SFP28 Board status LEDs FPGA Reset via host I2C
Environment	 Full height, ½ length 111.15 x 167.65 mm with bracket Storage temperature: -30 - 70°C -22 - 158°F Operating temperature (card inlet): 0 - 55°C, 30 - 130°F Operating humidity: 20 - 80% Hardware compliance: RoHS, FCC, CE
Power	 Max 75W Passive cooling Power and temperature monitoring via SMBus/I2C
Management	 SoC boot options: PXE, SATA SoC control interfaces: USB, UART, network
Networking	 A configurable packet processor IP core Extensive configuration API Packet forwarding and bridging across network, main host and SoC Parsing, match and action operations Bandwidth rate limit
Hardware Acceleration	 True hardware virtio interface virtio 0.95 virtio 1.0 virtio – vDPA with live migration backend support virtio-net backend over PCle virtio-blk backend over PCle virtio-iscis (fuure) NVMEoF RDMA OFED SR-IOV, 256 virtual functions 32 physical functions
Software Support	 DPDK XDP SPDK OVS KVM VMWARE OpenStack, Cinder client, Nova client Ceph RBD virtio 0.95 virtio 1.0

Ordering Information	
FB2XXVG@S10D11-HDNP	

v1.0

www.silicom-usa.com

Silicom Ltd. International Headquarters 14 Atir Yeda St. Kfar Sava 4464323 Israel Tel: (972)-9-764-4555 Silicom Connectivity Solutions Inc. USA Office 6 Forest Ave, Paramus New Jersey 07652 USA

Tel: 18004silicom (Toll Free no.)

www.silicom.dk

Silicom Denmark A/S Poppelgaardvej 11 DK-2860 Soeborg Denmark Phone +45 46 32 74 55 contactus@silicom.dk